FOR <b>M PTO-1595</b> (modified) (Rev. 6-93)	RE US-1	9-2002	'EET U.S. DEPA	ARTMENT OF COMMERCE Patent and Trademark Office
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To the Honorable Commissioner of P			attached original docu	ıments or copy th <b>er ic.</b>
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Jin-Hwa HEO, Soo-Jin HONG	18/0//00	Name: San	nsung Electronics Co.,	I td
		Internal Ad		
Additional name(s) of conveying party(ie	s) attached? No		ress: 416 Maetan-dong	
		City: Suwo	on-city, Kyungki-do, R	EPUBLIC OF KOREA
		Additional nan	ne(s) & address(es) attac	ched? No
3. Nature of conveyance:				
X Assignment Men Security Agreement Chang	rger ge of Name			
Other	ge of Name			
		ł		
Execution Date: July 26, 2002				<b></b>
4. Application number(s) or patent number	ber(s):	1215	3 <i>52</i>	
If this document is being filed together	er with a new application, t	he execution date of the	application is: July 26	, 2002
A. Patent Application No.(s)		B. Patent No.(	(s)	
	Additional	numbers attached? No		
5. Name and address of party to whom o	correspondence concerning	g 6. Total numb	per of applications and p	atents
document should be mailed:		involved: 9	One	
Name: Eugene M. Lee				
Internal Address: LEE & STERBA	. P.C.	,		
Street Address: 1101 Wilson Bouley				
City: Arlington, State: VA ZIP: 22	<u> 209</u>	7 Tatal for (2)	27.CED 2.41) (	140.00
		/. Total fee (3	37 C.F.R., 3.41)	540.00
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		X Autho	orized to be charged to d	eposit account
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To the best of my knowledge and beli	ef, the foregoing informati	ion is true and correct a	nd any attached copy is	a true copy of the original
document.				
Eugene M. Lee	543	and of	-	
Richard A. Sterba		araff fler	- August 9, 2002	4
Name of Person Signing	Signature		Date	
Total number of pag	es including cover sheet,	attachmets, and docur	ment: 2 pages attacher	l, incl. cover
	ocuments to be recorded			
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PATENT REEL: 013190 FRAME: 0802 239/167

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## **ASSIGNMENT**

name and address of assignee	For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each undersigned inventor has sold and assigned, and by these presents hereby sells and assigns, unto SAMSUNG ELECTRONICS CO., LTD.  416 Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea
	(hereinafter ASSIGNEE) all right, title and interest for the United States, its territories and possessions in and to his invention relating to
title of invention	A STRUCTURE OF TRENCH ISOLATION AND A METHOD OF FORMING THE SAME as set forth in this United States Patent Application
check one	X executed concurrently herewith  executed on
	Serial No Filed

in and to said United States Patent Application including any and all divisions or continuations thereof and in and to any and all Letters Patent of the United States which may issue on any such application or for said invention, including any and all reissues or extensions thereof, to be held and enjoyed by said ASSIGNEE, its successors, legal representatives and assigns to the full end of the term or terms for which any and all such Letters Patent may be granted as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made;

Each of the undersigned hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all such Letters Patent to said ASSIGNEE, its successors or assigns in accordance herewith;

Each of the undersigned warrants and covenants that he has the full and uncocumbered right to sell and assign the interests herein sold and assigned and that he has not executed and will not execute any document or instrument in conflict herewith;

Each of the undersigned further covenants and agrees he will communicate to said ASSIGNEE, its successors, legal representatives or assigns all information known to him relating to said invention or patent application and that he will execute and deliver any papers, make all rightful oaths, testify in any legal proceedings and perform all other lawful acts deemed necessary or desirable by said ASSIGNEE, its successors, legal representatives or assigns to perfect title to said invention, to said application including divisions and continuations thereof and to any and all Letters Patent which may be granted therefor or thereon, including reissues or extensions, in said ASSIGNEE, its successors, or assigns or to assist said ASSIGNEE, its successors, legal representatives or assigns in obtaining, reissuing or enforcing Letters Patent of the United States for said invention;

Each of the undersigned hereby grants the firm of LEE & STERBA, P.C. the power to insert in this Assignment any further identification which may be necessary or desirable to comply with the rules of the U.S. Patent and Trademark Office for recordation of this Assignment.

NAMES AND SIGNATURES OF INVENT	ORS
Signature:	Date 26. Tuly, 200
Signature: 500 jin Hong	Date: 16. July 2012
NAMES AND SIGNATURES OF WITNES	
Signature: 1244	Date: 26 July 100
Signature: 14531	Date: 26 July wor
	Signature: 500 10 Homg- NAMES AND SIGNATURES OF WITNES Signature: 72 400

Note: Prima facie evidence of execution may optionally be obtained by execution of this document before a U.S. Consul or before a local officer authorized to administer oaths whose authority is proved by a certificate from a U.S. Consul.

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